

# Anand Model: Theoretical Formulation and Application to Solder Joints

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## Source Paper

**Introduction to Anands Unified Viscoplasticity Model (1985)**

**Breakthrough Features of Anands Viscoplastic Model**

Formulation pipeline for Anands viscoplastic model

Broad Strokes of Anands Unified Viscoplastic Model (1985)

**Viscoelasticity: Stress Relaxation and Creep**

**Time-Dependent Strain in Elastic, Viscous, and Viscoelastic Materials**

**Primary Equations of Anand Model (1D)**

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**Material Parameters in Anands Viscoplastic Model**

How Anands Model Unifies Creep and Plasticity

**Case Study: Wang (2001)**

Anand Model Parameters for Common Solders

Comparing Anand Model Predictions at Two Strain Rates

Anand Approximation

What If the Material Were Not Viscoplastic?

**Summary of Motivation, Methods, Results, and Conclusions (Anand 1985)**

**Summary of Motivation, Methods, Results, and Conclusions (Wang 2001)**

**Summary of Anands Model**

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2

**Constitutive Equations for Isotropic Thermo-Elasto-Viscoplasticity**

**Theoretical Stress-Strain Formulation**

**Stress as a Function of Plastic Strain  $\varepsilon^p$**  Using the integrated model, the stress-strain relation becomes:

- $\sigma_0$ : initial yield stress
- $\sigma^*$ : saturation stress (UTS)
- $c, h_0, a$ : shape and evolution constants